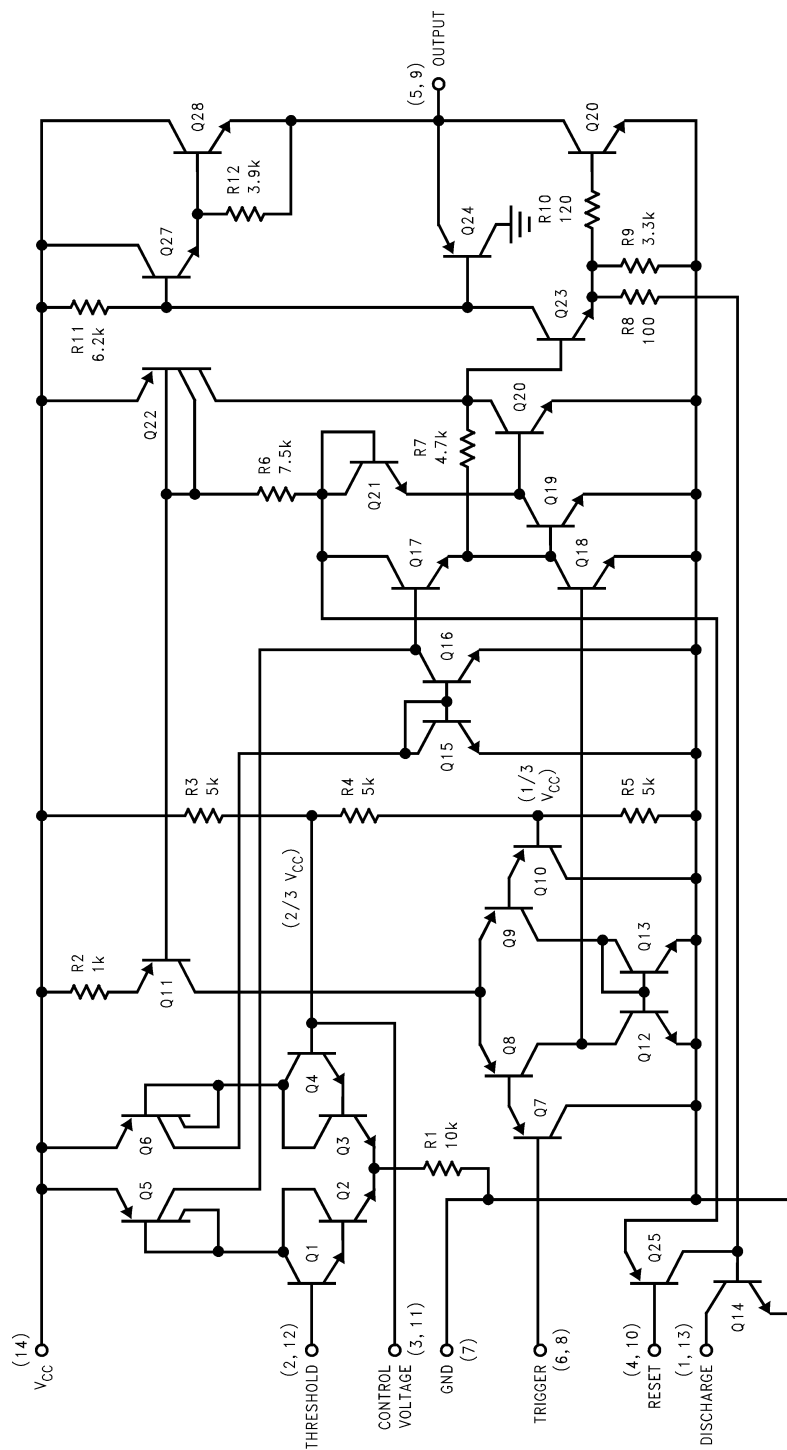




## Schematic Diagram



DS007852-2

**Absolute Maximum Ratings** (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage	+18V
Power Dissipation (Note 2)	
LM556CM	410 mW
LM556CN	1620 mW
Operating Temperature Ranges	
LM556C	0°C to +70°C

Storage Temperature Range

-65°C to +150°C

Soldering Information

Dual-In-Line Package

Soldering (10 Seconds) 260°C

Small Outline Packages

Vapor Phase (60 Seconds) 215°C

Infrared (15 Seconds) 220°C

See AN-450 "Surface Mounting Methods and Their Effect on Product Reliability" for other methods of soldering surface mount devices.

**Electrical Characteristics**(T<sub>A</sub> = 25°C, V<sub>CC</sub> = +5V to +15V, unless otherwise specified)

Parameter	Conditions	Limits			Units
		LM556C			
		Min	Typ	Max	
Supply Voltage		4.5		16	V
Supply Current (Each Timer Section)	V <sub>CC</sub> = 5V, R <sub>L</sub> = ∞ V <sub>CC</sub> = 15V, R <sub>L</sub> = ∞ (Low State) (Note 3)		3 10	6 14	mA
Timing Error, Monostable	R <sub>A</sub> = 1k to 100kΩ, C = 0.1μF, (Note 4)				% ppm/°C  % %/V
Initial Accuracy			0.75		
Drift with Temperature			50		
Accuracy over Temperature			1.5		
Drift with Supply			0.1		
Timing Error, Astable	R <sub>A</sub> , R <sub>B</sub> = 1k to 100kΩ, C = 0.1μF, (Note 4)				% ppm/°C % %/V
Initial Accuracy			2.25		
Drift with Temperature			150		
Accuracy over Temperature			3.0		
Drift with Supply			0.30		
Trigger Voltage	V <sub>CC</sub> = 15V	4.5	5	5.5	V
	V <sub>CC</sub> = 5V	1.25	1.67	2.0	V
Trigger Current			0.2	1.0	μA
Reset Voltage		0.4	0.5	1	V
Reset Current			0.1	0.6	mA
Threshold Current	V <sub>TH</sub> = V-Control (Note 6) V <sub>TH</sub> = 11.2V		0.03	0.1 250	μA nA
Control Voltage Level and Threshold Voltage	V <sub>CC</sub> = 15V	9	10	11	V
	V <sub>CC</sub> = 5V	2.6	3.33	4	
Pin 1, 13 Leakage Output High			1	100	nA
Pin 1, 13 Sat	(Note 7)				
Output Low	V <sub>CC</sub> = 15V, I = 15mA		180	300	mV
Output Low	V <sub>CC</sub> = 4.5V, I = 4.5mA		80	200	mV
Output Voltage Drop (Low)	V <sub>CC</sub> = 15V				
	I <sub>SINK</sub> = 10mA		0.1	0.25	V
	I <sub>SINK</sub> = 50mA		0.4	0.75	V
	I <sub>SINK</sub> = 100mA		2	2.75	V
	I <sub>SINK</sub> = 200mA		2.5		V
	V <sub>CC</sub> = 5V				
	I <sub>SINK</sub> = 8mA				V
	I <sub>SINK</sub> = 5mA		0.25	0.35	V

Electrical Characteristics (Continued)

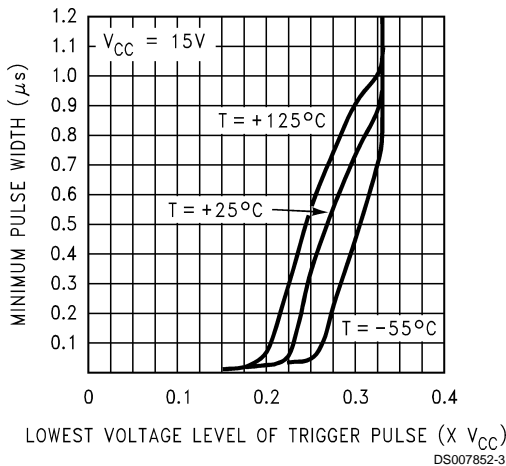
(T<sub>A</sub> = 25°C, V<sub>CC</sub> = +5V to +15V, unless otherwise specified)

Parameter	Conditions	Limits			Units
		LM556C			
		Min	Typ	Max	
Output Voltage Drop (High)	I <sub>SOURCE</sub> = 200mA, V <sub>CC</sub> = 15V		12.5		V
	I <sub>SOURCE</sub> = 100mA, V <sub>CC</sub> = 15V	12.75	13.3		V
	V <sub>CC</sub> = 5V	2.75	3.3		V
Rise Time of Output			100		ns
Fall Time of Output			100		ns
Matching Characteristics	(Note 8)				
Initial Timing Accuracy			0.1	2.0	%
Timing Drift with Temperature			±10		ppm/°C
Drift with Supply Voltage			0.2	0.5	%/V

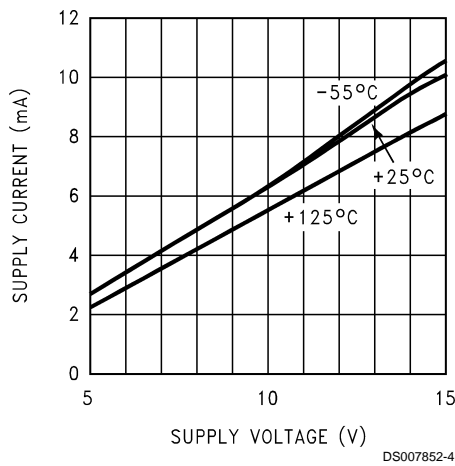
- Note 1:** Absolute Maximum Ratings indicate limits beyond which damage to the device may occur.
- Note 2:** For operating at elevated temperatures the device must be derated based on a +150°C maximum junction temperature and a thermal resistance of 77°C/W (Plastic Dip), and 110°C/W (SO-14 Narrow).
- Note 3:** Supply current when output high typically 1mA less at V<sub>CC</sub> = 5V.
- Note 4:** Tested at V<sub>CC</sub> = 5V and V<sub>CC</sub> = 15V.
- Note 5:** As reset voltage lowers, timing is inhibited and then the output goes low.
- Note 6:** This will determine the maximum value of R<sub>A</sub> + R<sub>B</sub> for 15V operation. The maximum total (R<sub>A</sub> + R<sub>B</sub>) is 20 MΩ.
- Note 7:** No protection against excessive pin 1, 13 current is necessary providing the package dissipation rating will not be exceeded.
- Note 8:** Matching characteristics refer to the difference between performance characteristics of each timer section.
- Note 9:** Refer to RETS556X drawing of military LM556J versions.

Typical Performance Characteristics

Minimum Pulse Width Required for Triggering

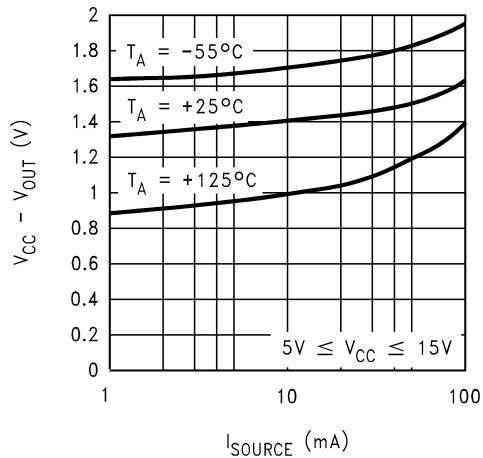


Supply Current vs. Supply Voltage (Each Section)



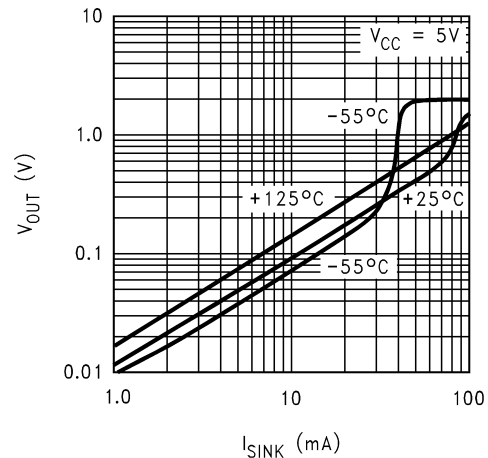
# Typical Performance Characteristics (Continued)

## High Output Voltage vs. Output Source Current



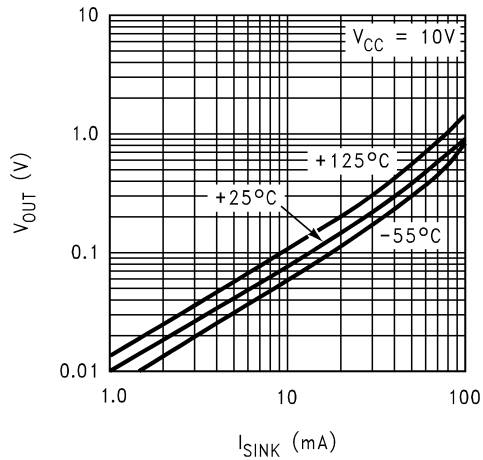
DS007852-5

## Low Output Voltage vs. Output Sink Current



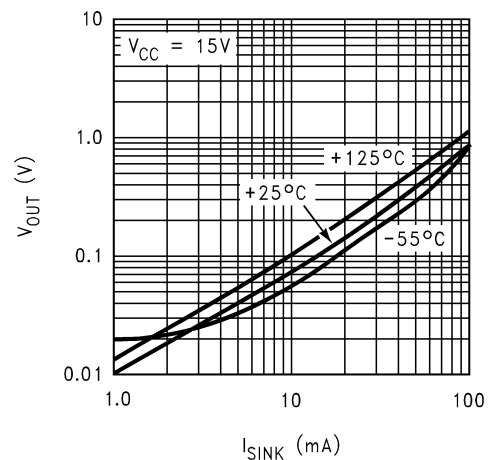
DS007852-6

## Low Output Voltage vs. Output Sink Current



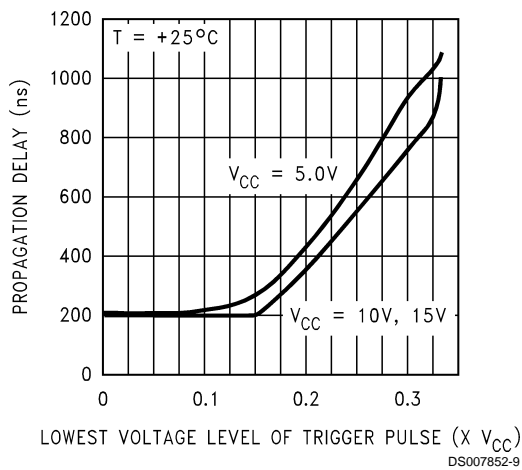
DS007852-7

## Low Output Voltage vs. Output Sink Current



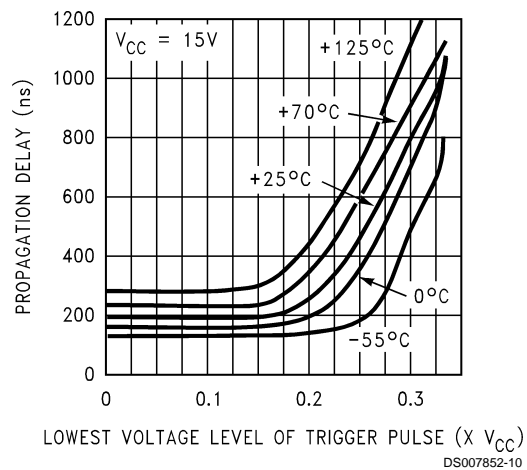
DS007852-8

## Output Propagation Delay vs. Voltage Level of Trigger Pulse



DS007852-9

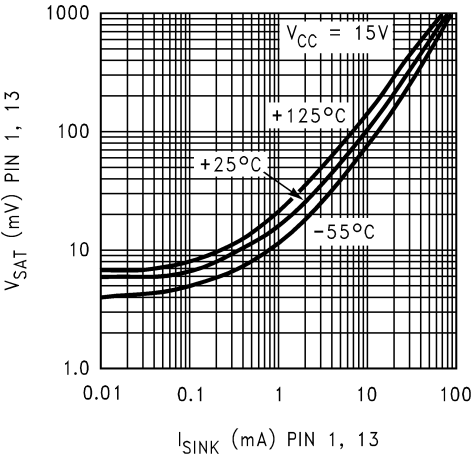
## Output Propagation Delay vs. Voltage Level of Trigger Pulse



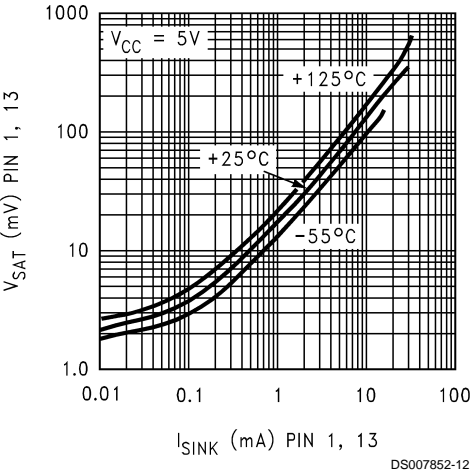
DS007852-10

Typical Performance Characteristics (Continued)

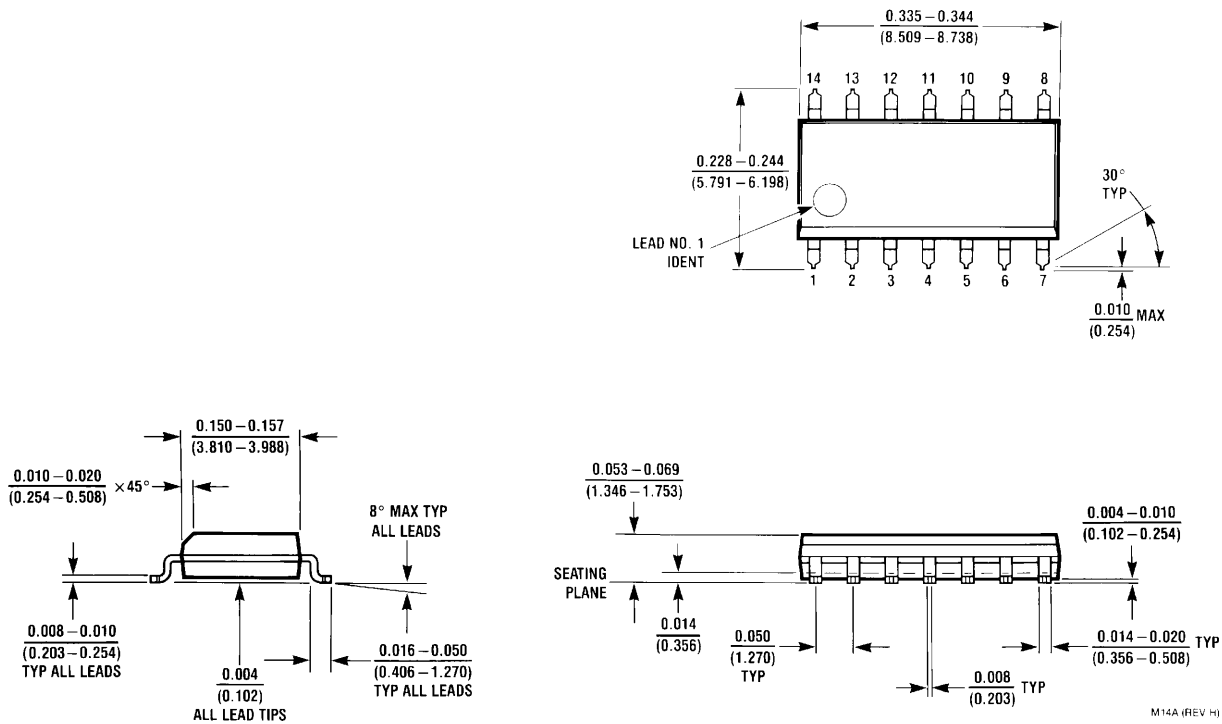
Discharge Transistor (Pin 1, 13) Voltage vs. Sink Current



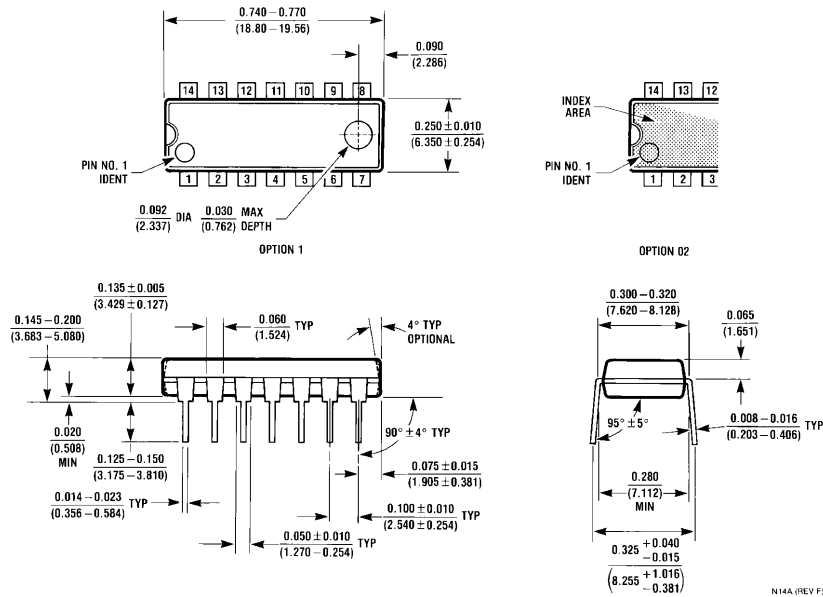
Discharge Transistor (Pin 1, 13) Voltage vs. Sink Current



# Physical Dimensions inches (millimeters) unless otherwise noted



**Small Outline Package (M)**  
**NS Package Number M14A**



**14-Lead (0.118" Wide) Molded Mini Small Outline Package**  
**NS Package Number N14A**

## Notes

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